

Docket No.: M-9954 US

728.00

May 4, 2001

Box Patent Application Commissioner For Patents Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventors:

Paul Hoffman and Doug Mathews

Title:

Shielded Semiconductor Package With Single-Sided Substrate And

Method For Making The Same

X Return Receipt Postcard

X This Transmittal Letter (in duplicate)
pages Specification (not including claims)

5 pages Claims
1 page Abstract

1 page Abstract
4 Sheets of Drawings

pages Declaration For Patent Application and Power of Attorney

page NonPublication Request

page Recordation Form Cover Sheet (in duplicate)

2 pages Assignment

page PTO Form 1449 citing seven references
Copies of 7 Cited References submitted

CLAIMS AS FILED

For Total Claims	Number Filed 21	-20	=	Number Extra 1	x	<u>Rate</u> \$ 18.00	=	\$ \$	Basic Fee 710.00 18.00
Independent Claims	3	-3	=	0	х	\$80	=	\$	0.00
Fee of for the first filing of one or more multiple dependent claims per application								\$	
Fee for Request for Extension of Time								\$	
Pleas	e make the fol	lowing	charg	es to Deposit	Accou	int 19-2386:			

Total fee for filing the patent application in the amount of

The Commissioner is hereby authorized to charge any additional fees which may be

required, or credit any overpayment to Deposit Account 19-2386.

EXPRESS MAIL LABEL NO:

EL 701 020 822 US

Respectfully submitted,

Daniel P. Stewart

Attorney for Applicants

Reg. No. 41,332



REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

Inventors Paul Hoffman and Doug Mathews

Shielded Semiconductor Package With
Single-Sided Substrate And Method For
Making The Same

Atty Docket Number M-9954 US

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

May 4, 2001 Date

Daniel P. Stewart Attorney for Applicants Reg. No.: 41,332

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).